DECLARATION FOR PATENT APPLICATION (WITH POWER OF ATTORNEY)

As an inventor named below or on any attached continuation page, I hereby declare that: My residence, post office address and citizenship are as stated next to my name.

I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled PROGRAMMED MATERIAL CONSOLIDATION SYSTEM INCLUDING MULTIPLE FABRICATION SITES AND ASSOCIATED METHODS, the specification of which (check one):

			ion (oncom onc).		
	is attached hereto. was filed on was amended on was filed on was amended under PC	 as PCT	international applica	serial no	and and
	by state that I have revie including the claims, as				
known to me t	owledge the duty to disc to be material to the pate s defined in Title 37, Co	entability of the	e subject matter clain		
365(b) of any international a listed below as attached continuity international a	by claim foreign priority foreign application(s) for pplication(s) designation on any attached continuation page any foreign pplication(s) designating date before that of the application is the second continuation page.	or patent or inverse at least one control at least one control at least one for at least one control at least one	entor's certificate or country other than the and have also identified patent or inventor' country other than the	§ 365(a) of United Stated below are s certificated United States	any PCT ates of America and on any or any PCT
Prior foreign/I	PCT application(s):			Priority	Claimed
(numbe	er) (co	untry)	(day/month/year filed)	Yes	No

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) or § 365(c) of PCT international application(s) designating the United States of America listed below and on any attached continuation page and, insofar as the subject matter of each of the claims of this application is not disclosed in any such prior application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose to the U.S. Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations § 1.56 which became available

(day/month/year filed)

Yes

No

(country)

(number)

DECLARATION FOR PATENT APPLICATION

(continuation page)

Invention Title: PROGRAMMED MATERIAL CONSOLIDATION SYSTEM INCLUDING MULTIPLE FABRICATION SITES AND ASSOCIATED METHODS

(application serial no.)	(filing date)	(status-pending, patented or abandoned)
(application serial no.)	(filing date)	(status-pending, patented or abandoned)

I hereby appoint the following Registered Practitioners to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements

DECLARATION FOR PATENT APPLICATION

(continuation page)

Invention Title: PROGRAMMED MATERIAL CONSOLIDATION SYSTEM INCLUDING MULTIPLE FABRICATION SITES AND ASSOCIATED METHODS

were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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